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SHARP

OPTO-ELECTRONIC DEVICES DIVISION
ELECTRONIC COMPONENTS GROUP
SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

PHOTOTRIAC COUPLER

MODEL No.

4SF11

| | | | |
|--|-----------------------|--|-----------------------|
| | Business dealing name | | Business dealing name |
| | PC4SF11NTZBF | | PC4SF11YTZBF |

Specified for _____

Enclosed please find copies of the Specifications which consists of 14 pages including cover.
After confirmation of the contents, please be sure to send back copies of the Specifications
with approving signature on each.

CUSTOMER'S APPROVAL

PRESENTED

DATE

DATE

BY

BY K.M

K. Hachimura,
Department General Manager of
Engineering Dept.,II
Opto-Electronic Devices Div.
ELECOM Group
SHARP CORPORATION

1/10
HP-03-104 PC4SF11NTZBF
June 19, 2003
REFERENCE

Product name : PHOTOTRIAC COUPLER

Model No. : 4SF11

(Business dealing name : PC4SF11NTZBF)

(Business dealing name : PC4SF11YTZBF)

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas ;

(· OA equipment · Audio visual equipment · Home appliances
· Telecommunication equipment (Terminal) · Measuring equipment
· Tooling machines · Computers)

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;

(· Transportation control and safety equipment (aircraft, train, automobile etc.)
· Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
· Other safety equipment etc.)

- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

(· Space equipment · Telecommunication equipment (for trunk lines)
· Nuclear power control equipment · Medical equipment etc.)

- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of phototriac coupler Model No. 4SF11 (Apply line voltage 200V AC).

2. Outline

Refer to the attached sheet, page 4.

3. Ratings and characteristics

Refer to the attached sheet, page 5, 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

6. Supplement

6.1 Business dealing name

("○" mark indicates business dealing name of ordered product)

| Product | Business dealing name | Remarks |
|---------|-----------------------|--|
| | PC4SF11NTZBF | |
| | PC4SF11YTZBF | * Applied to products as an option (Attachment-3-1 to 3-3) |

6.2 Package specification

Refer to the attached sheet, page 9, 10.

6.3 Isolation voltage shall be measured in the following method.

- (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
- (2) The dielectric withstand tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.


(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL, CSA.

Approved Model No. : 4SF11

UL file No. : E64380

CSA file No. : CA95323

CSA approved mark "  " shall be indicated on sleeve package.

6.5 This product is approved by BSI, SEMKO, DEMKO and FIMKO

Approved Model No. : 4SF11

BSI Certificate No. : 6690/7421 (BS415/BS7002)

SEMKO Certificate No. : 0033029/01-04

DEMKO Certificate No. : 310107-01

FIMKO Certificate No. : 15795

6.6 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.7 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1,1,1-Trichloroethane (Methyl chloroform)

6.8 Brominated flame retardants

Specific brominated flame retardants such as the PBBO₅ and PBB₅ are not used in this device at all.

7. Notes

7.1 Before the circuit design

- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value as 2 times or more of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)
- (2) Input current (I_F) at off state shall be set 0.1mA or less.
- (3) In case that pulse drive is carried out, it shall be recommended to use that the pulse width of input signal is 1ms or more.

7.2 Usage

For triggering medium and high power triac. (This model shall be used in the ON state condition of triggering power triac.)

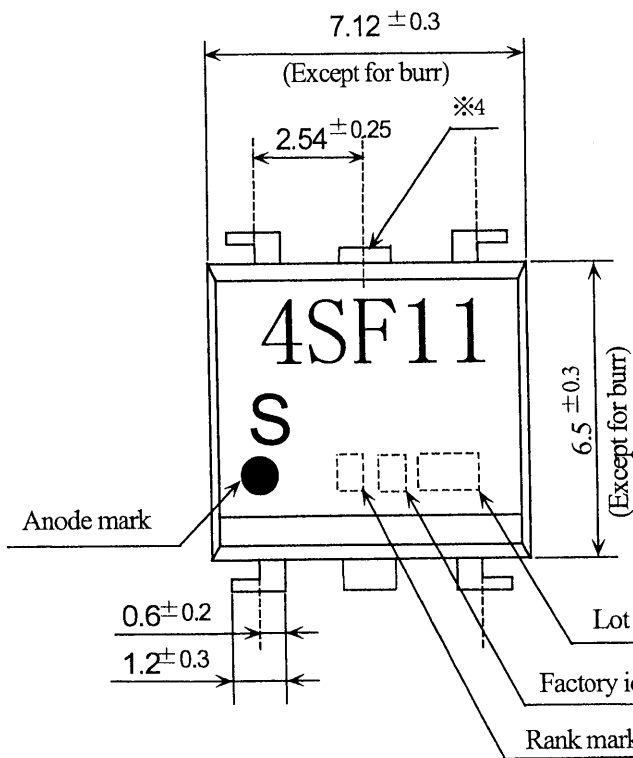
7.3 For cleaning

- (1) Solvent cleaning : Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
When the other solvent is used, there are cases that the packaging resin is eroded. Please use the other solvent after thorough confirmation is performed in actual using condition.

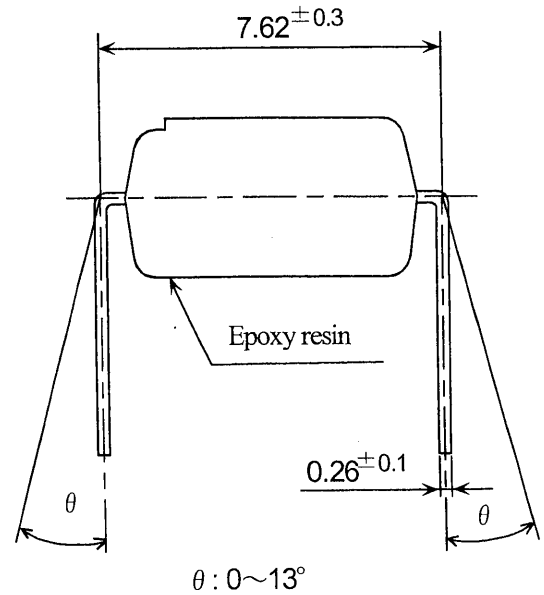
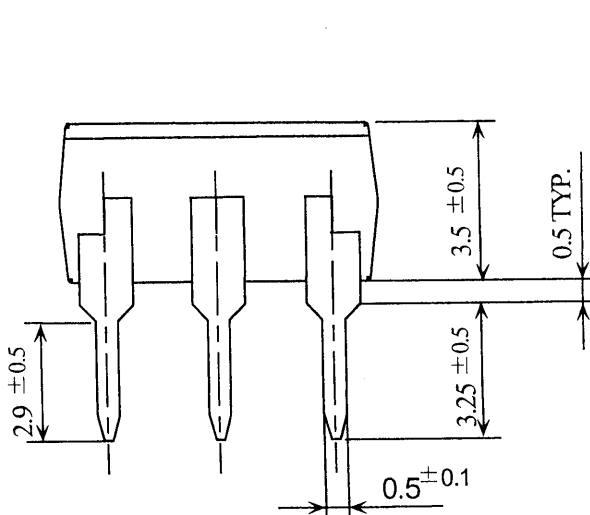
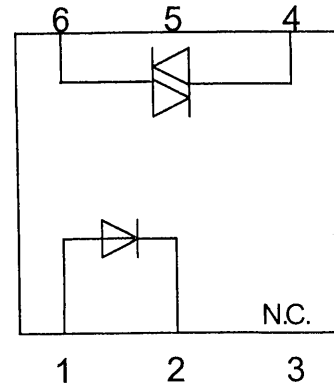
7.4 Precautions for Soldering Phototriac couplers

- (1) In the case of flow soldering (Whole device dipping)
It is recommended that flow solder be at 270°C and within 10 seconds (Pre-heating : 100 to 150°C, 30 to 80seconds).
(2 times or less)
- (2) In the case of hand soldering
What is done on the following condition is recommended.(2 times or less)
Soldering iron temperature : 390±10°C
Time : 3s or less
- (3) Other precautions
Depend on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different. Please confirm that there is no problem on the actual use conditions.

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Pin Nos. and internal connection diagram



- *1) 2-digit number shall be marked according to DIN standard.
- *2) Factory identification mark shall be or shall not be marked.
- *3) Rank mark : "B"
- *4) Pin 5 is not allowed external connection.
Pin 5 is cut at outside of package.
- *5) Lead material : Cu Alloy
Lead finish : SnCu plating (Cu : TYP. 2%)

Product mass : Approx.0.35g

| | |
|---------------|--|
| UNIT : 1/1 mm | |
| Name | 4SF11 Outline Dimensions (Business dealing name : PC4SF11NTZBF) |

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3.1 Absolute maximum ratings

Ta=25°C

| Parameter | | Symbol | Rating | Unit |
|-----------------------|-----------------------------------|------------------------------|----------------------|------|
| Input | Forward current *1 | I_F | 50 | mA |
| | Reverse voltage | V_R | 6 | V |
| Output | RMS on-state current *1 | $I_T(\text{rms})$ | 0.1 | A |
| | Peak one cycle surge current | I_{surge} | 1.2 (50Hz sine wave) | A |
| | Repetitive peak off-state voltage | V_{DRM} | 800 | V |
| Isolation voltage *2 | | $V_{\text{iso}}(\text{rms})$ | 5 | kV |
| Operating temperature | | T_{opr} | -30 to +100 | °C |
| Storage temperature | | T_{stg} | -55 to +125 | °C |
| Soldering temperature | | T_{sol} | 270 (For 10s) | °C |

*1 The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

*2 AC for 1min, 40 to 60%RH, f=60Hz

3.2 Electrical characteristics

Ta=25°C

| Parameter | | Symbol | MIN. | TYP. | MAX. | Unit | Conditions |
|--------------------------|--|------------------|--------------------|-----------|--------------------|------------------|--|
| Input | Forward voltage | V_F | - | 1.2 | 1.4 | V | $I_F=20\text{mA}$ |
| | Reverse current | I_R | - | - | 10^{-5} | A | $V_R=3\text{V}$ |
| Output | Repetitive peak off-state current | I_{DRM} | - | - | 3×10^{-6} | A | $V_D=V_{\text{DRM}}$ |
| | On-state voltage | V_T | - | - | 2.5 | V | $I_T=0.1\text{A}$ |
| | Holding current | I_H | 0.1 | - | 3.5 | mA | $V_D=6\text{V}$ |
| | Critical rate of rise of off-state voltage | dv/dt | 50 | - | - | V/ μs | $V_D=1/\sqrt{2} \cdot V_{\text{DRM}}$ |
| Transfer characteristics | Minimum trigger current | I_{FT} | - | - | 7 | mA | $V_D=6\text{V}$ $R_L=100\Omega$ |
| | Isolation resistance | R_{ISO} | 5×10^{10} | 10^{11} | - | Ω | DC500V 40 to 60%RH |
| | Turn on time | t_{ON} | - | - | 100 | μs | $V_D=6\text{V}, R_L=100\Omega,$ $I_F=20\text{mA}$ |

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Fig.1 Forward current vs. ambient temperature

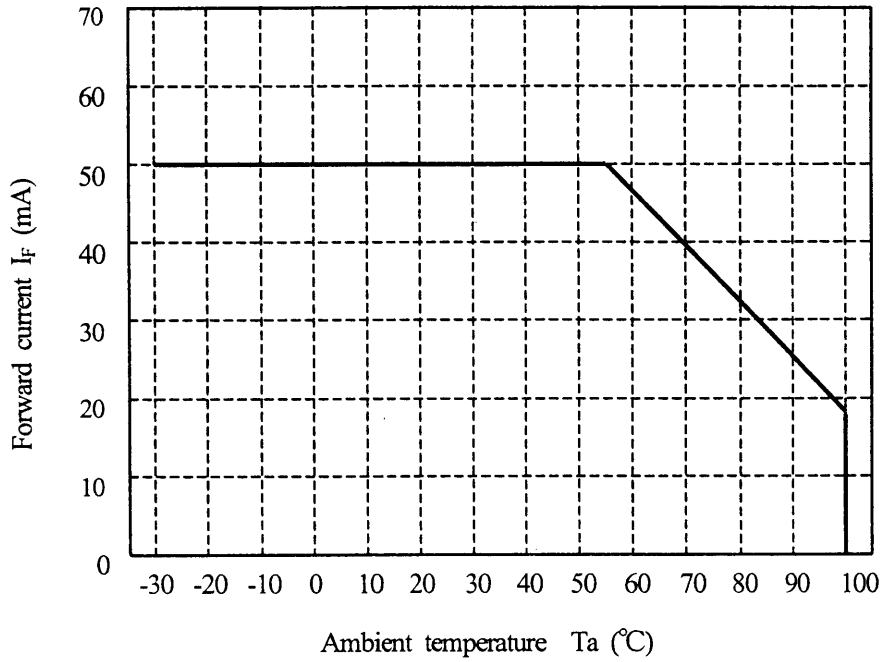
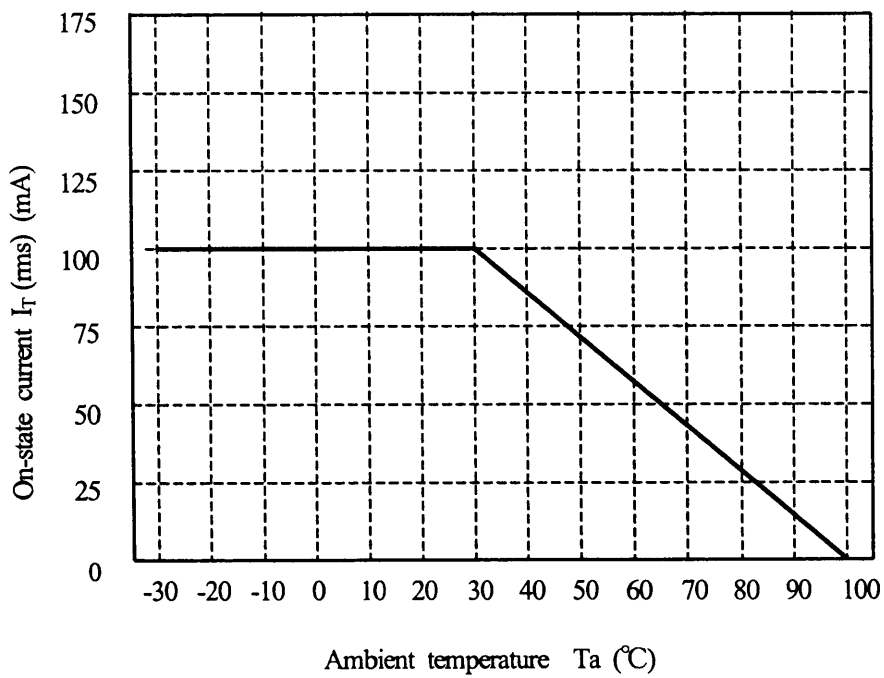


Fig.2 On-state current I_T (mA) vs. ambient temperature



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4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level : 90%

LTPD : 10 or 20

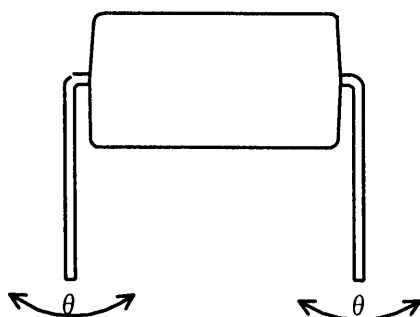
| Test Items | Test Conditions *1 | Failure Judgement Criteria | Samples (n) |
|--------------------------------------|--|---|--------------|
| | | | Defective(C) |
| Solderability *2 | 245±3°C, 5 s | $V_F > U \times 1.2$ $V_T > U \times 1.2$ $I_{FT} > U \times 1.3$ $I_R > U \times 2.0$ $I_{DRM} > U \times 2.0$ U : Upper specification limit L : Lower specification limit | n=11, C=0 |
| Soldering heat *3 | (Flow soldering) 270°C, 10 s | | n=11, C=0 |
| | (Soldering by hand) 400°C, 3 s | | n=11, C=0 |
| Terminal strength (Tension) | Weight : 5.0N 5 s/each terminal | | n=11, C=0 |
| Terminal strength (Bending) *4 | Weight : 2.5N 2 times/each terminal | | n=11, C=0 |
| Mechanical shock | 15km/s ² , 0.5ms 3 times/±X, ±Y, ±Z direction | | n=11, C=0 |
| Variable frequency vibration | 100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction | | n=11, C=0 |
| Temperature cycling | 1 cycle -55°C to +125°C (30min) (30min) 20 cycles test Without Load | | n=22, C=0 |
| High temp. and high humidity storage | +85°C, 85%RH, 500h | | n=22, C=0 |
| High temp. storage | +125°C, 1000h | | n=22, C=0 |
| Low temp. storage | -55°C, 1000h | n=22, C=0 | |
| Operation life | I _F =50mA, I _T =100mA T _a =25°C, 1000h | n=22, C=0 | |

*1 Test method, conforms to EIAJ ED 4701.

*2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.

*3 Dip into the position of 1.0mm from the resin part.

*4 Terminal bending direction is shown below.



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5. Outgoing inspection

5.1 Inspection items

(1) Electrical characteristics

 $V_F, I_R, I_{DRM}, V_T, I_{FT}, R_{ISO}, V_{ISO}$

(2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied.

The AQL according to the inspection items are shown below.

| Defect | Inspection item | AQL (%) |
|--------------|--|---------|
| Major defect | Electrical characteristics Unreadable marking | 0.065 |
| Minor defect | Appearance defect except the above mentioned. | 0.25 |

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6.2 Package specification

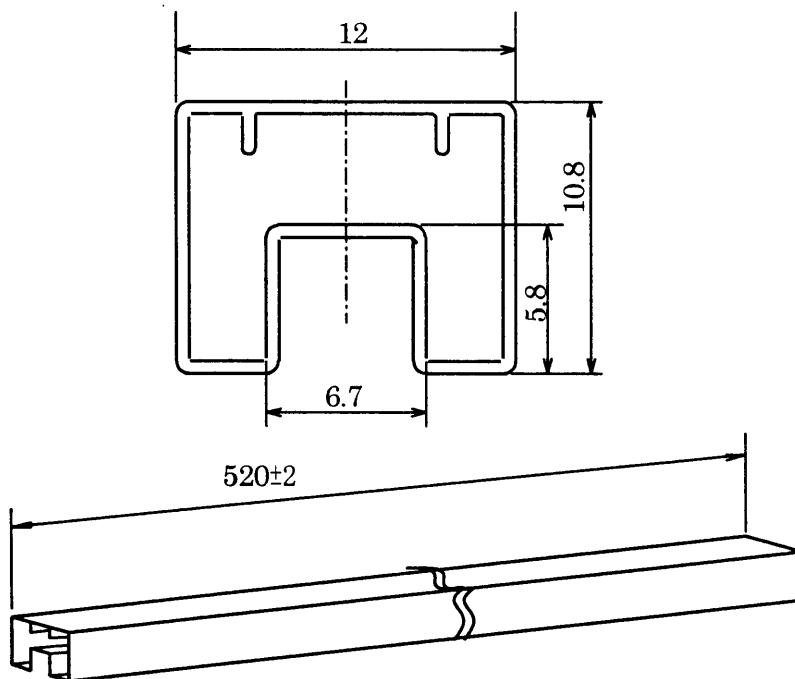
6.2.1 Package materials

| No. | Name | Materials | Purposes |
|-----|--------------|---|--|
| ① | Sleeve | HIPS with preventing static electricity | Products packaged |
| ② | Stopper | Styrene-Elastomer | Products fixed |
| ③ | Packing case | Corrugated cardboard | Sleeve packaged |
| ④ | Kraft tape | Paper | Lid of packaged case fixed |
| ⑤ | Label | Paper | Model No., quantity, inspection date and lot No. specified |

6.2.2 Package method

- (1) MAX. 50pcs. of products shall be packaged in a sleeve ① and both of sleeve edges shall be fixed by stoppers ②.
- (2) MAX. 20 sleeves (product : 1000pcs.) above shall be packaged in a packing case ③ and pack a sheet of cushion at one side.
- (3) Model No., quantity, inspection date and lot No. shall be marked on the label ⑤ and this label shall be put on the side of the packaging case.
- (4) Case shall be closed with the lid and enclosed with kraft tape ④.

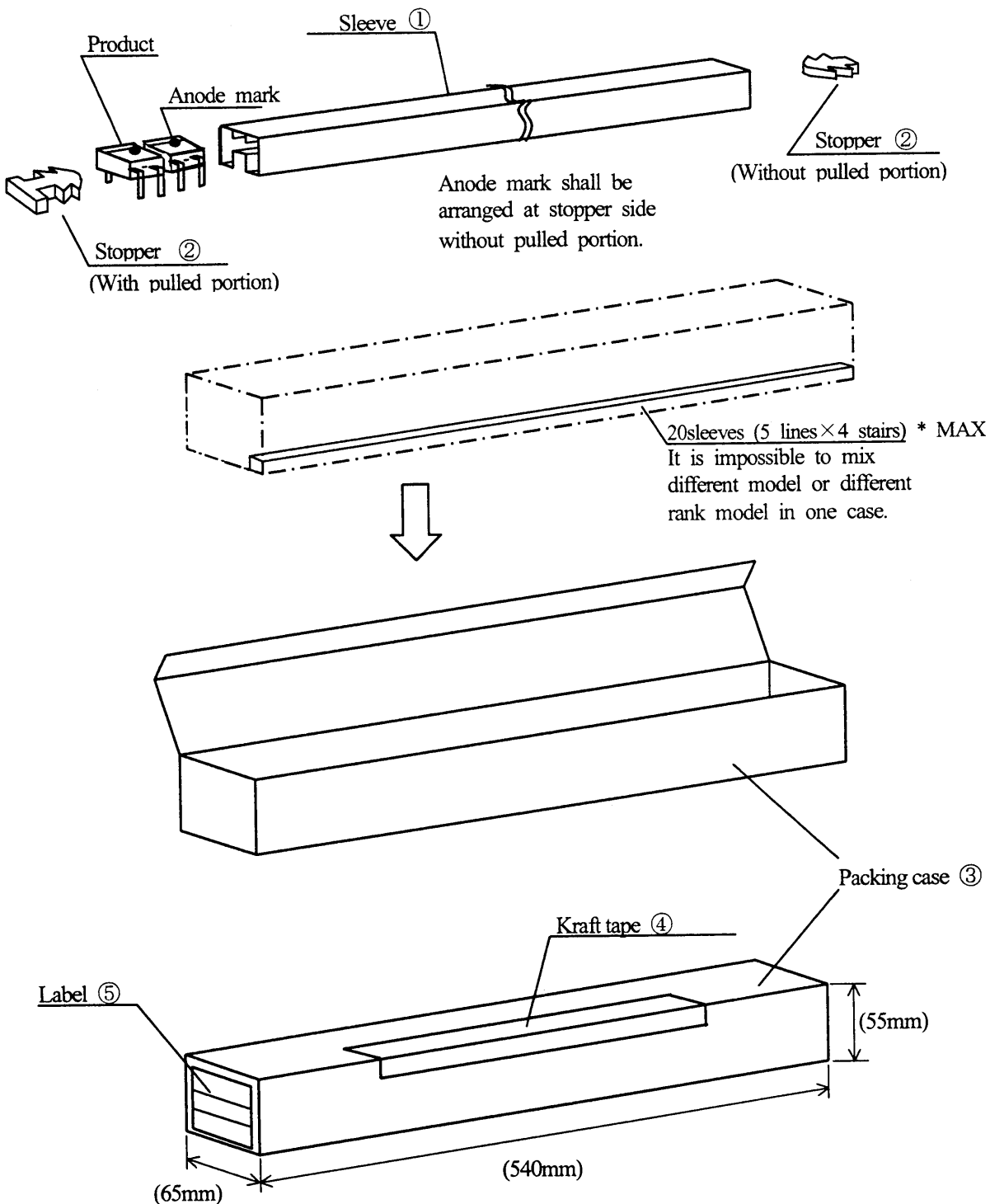
6.2.3 Sleeve package ① outline dimensions



- Note 1) Thickness : 0.5 ± 0.2 mm
 2) Outer R : 0.5mm
 3) Process with applying antistatic treatment.
 4) Unless otherwise specified tolerances shall be ± 0.5 mm.
 (However except for deformation due to the rubber stopper in sleeve.)

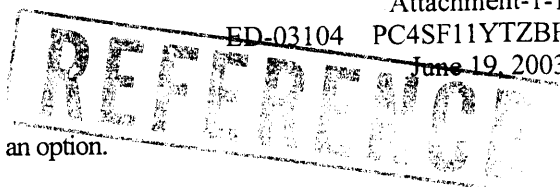
REFERENCE

6.2.4 Packing case outline dimensions



Regular packing mass : Approx. 760g

() : Reference value




1. This specification shall be applied to photocoupler, Model No. 4SF11 series as an option.
2. Applicable Models (Business dealing name)
PC4SF11YTZBF
3. The relevant models are the models Approved by VDE according to DIN VDE0884/08.87.

Model No. : 4SF11

VDE approved No. : 127413 (According to the specification DIN VDE0884/08.87)

- Operating isolation voltage $U_{IORM(PEAK)}$: 890V
- Transient voltage $U_{TR(PEAK)}$: 6000V
- Pollution : 2 (According to VDE0110/01.89)
- Clearances distance (Between input and output) : 8.0mm (MIN.)
- Creepage distance (Between input and output) : 8.0mm (MIN.)
- Isolation thickness between input and output : 0.40mm (MIN.)
- Tracking-proof : CTI 175 (Material group IIIa : VDE0110/01.89)
- Safety limit values
 - Current (Isi) : 200mA (Diode side)
 - Power (Psi) : 400mW (Phototriac side)
 - Temperature (Tsi) : 150°C

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

- Indication of VDE approval prints "  0884" on sleeve package.

4. Outline

Refer to the attachment-1-2.

5. Isolation specification according to VDE 0884

| Parameter | Symbol | Conditions | Rating | Unit | Remark |
|--|---------------------|--------------------------------------|----------------|----------|---|
| Class of environmental test | - | DIN IEC68 | 30/100/21 | - | Refer to the Diagram 1, 2 (Attachment -1-3) |
| Pollution | - | DIN VDE0110 | 2 | - | |
| Maximum operating isolation voltage | $U_{IORM(PEAK)}$ | - | 890 | V | |
| Partial discharge test voltage (Between input and output) | Diagram 1 | $t_p=60\text{ s}, q_c < 5\text{ pC}$ | 1068 | V | |
| | Diagram 2 | $t_p=1\text{ s}, q_c < 5\text{ pC}$ | 1424 | V | |
| Maximum over-voltage | $U_{INITIAL(PEAK)}$ | $t_{IN}=10\text{ s}$ | 6000 | V | |
| Safety maximum ratings | | | | | |
| 1) Case temperature | Tsi | $I_f=0, P_c=0$ | 150 | °C | Refer to Fig.1, 2 (Attachment -1-3) |
| 2) Input current | Isi | $P_c=0$ | 200 | mA | |
| 3) Electric power (Output or Total power dissipation) | Psi | - | 400 | mW | |
| Isolation resistance (Test voltage between input and output ; DC 500V) | R_{ISO} | $T_a=T_{si}$ | MIN. 10^9 | Ω | |
| | | $T_a=T_{opr}(\text{MAX.})$ | MIN. 10^{11} | | |
| | | $T_a=25^\circ\text{C}$ | MIN. 10^{12} | | |

6. Precautions in performing isolation test

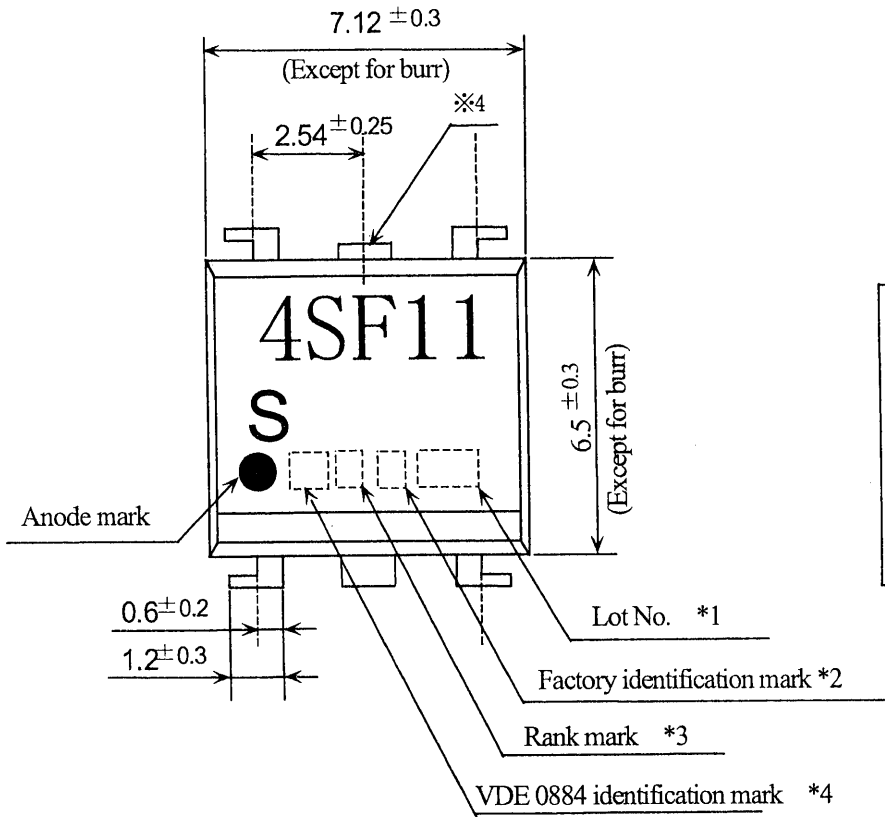
6.1 Partial discharge test methods shall be the ones according to the specifications of VDE 0884/08.87

6.2 Please don't carry out isolation test (Viso) over $U_{INITIAL}$.

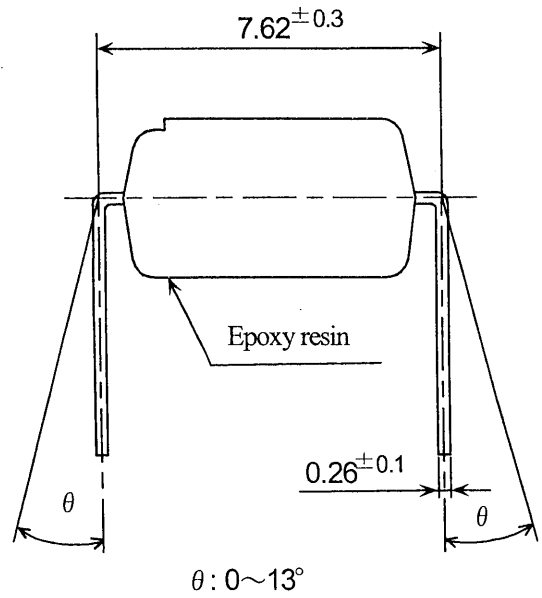
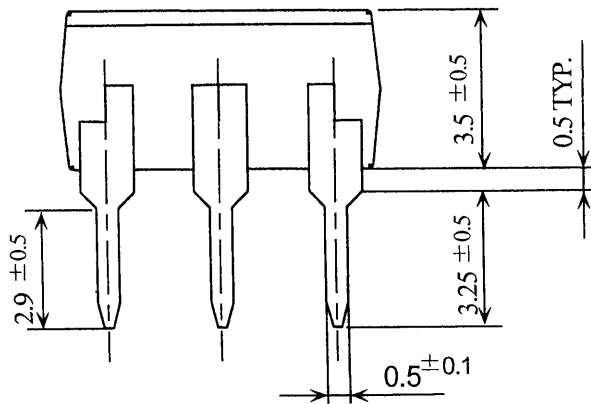
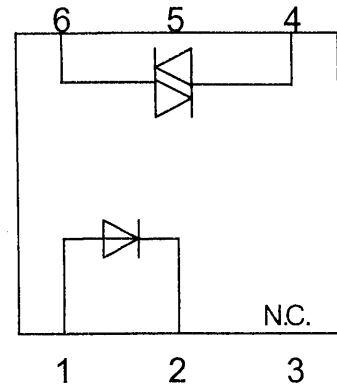
This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. $U_{INITIAL}$).

And there is possibility that this product occurs partial discharge in operating isolation voltage. (U_{IORM})

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Pin Nos. and internal connection diagram



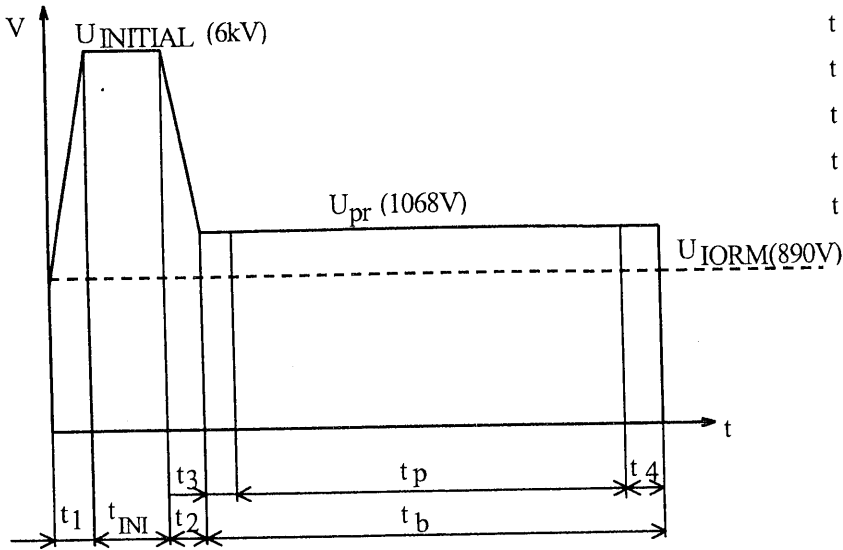
- *1) 2-digit number shall be marked according to DIN standard.
- *2) Factory identification mark shall be or shall not be marked.
- *3) Rank mark : "B"
- *4) VDE identification mark shall be marked "4"
- *5) Pin 5 is not allowed external connection.
Pin 5 is cut at outside of package.
- *6) Lead material : Cu Alloy
Lead finish : SnCu plating (Cu : TYP. 2%)

Product mass : Approx.0.35g

| | |
|---------------|--|
| UNIT : 1/1 mm | |
| Name | 4SF11 Outline Dimensions (Business dealing name : PC4SF11YTZBF) |

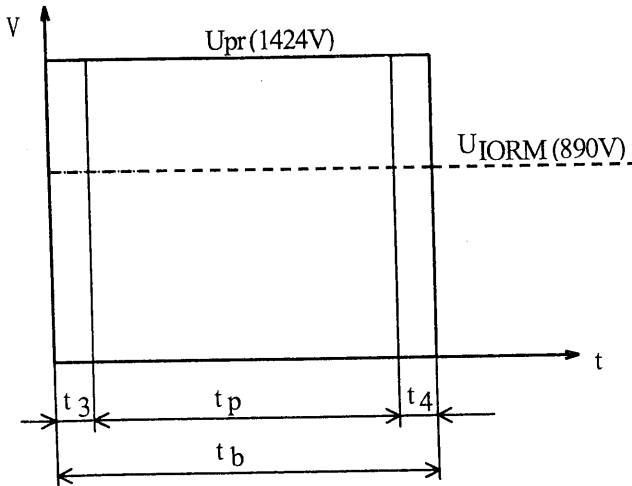
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Method of Diagram 1 : Breakdown test (Apply to type test and sampling test)



| | |
|--|-------------|
| t_1, t_2 | = 1 to 10 s |
| t_3, t_4 | = 1 s |
| t_p (Partial discharge measuring time) | =60 s |
| t_b | =62 s |
| t_{INI} | =10 s |

Method of Diagram 2 : Non breakdown test (Apply to all device test)



| | |
|--|--------|
| t_3, t_4 | =0.1 s |
| t_p (Partial discharge measuring time) | =1 s |
| t_b | =1.2 s |

Fig. 1 Safety maximum power dissipation vs. ambient temperature (When failed)

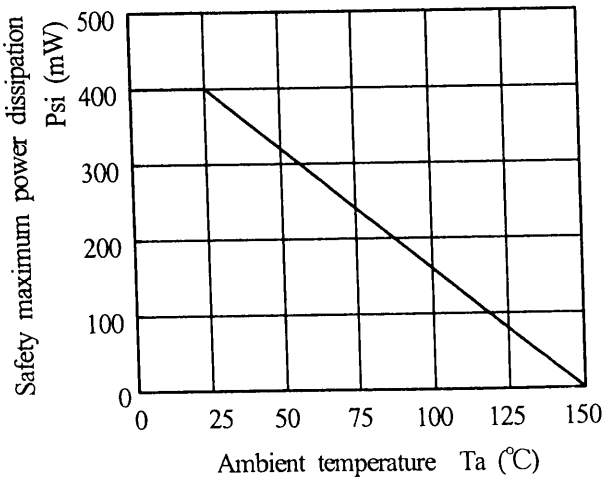


Fig. 2 Safety maximum forward current vs. ambient temperature (When failed)

